



Product Change Notification

108832 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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Product Change Notification

Change Notification #: 108832 - 00
Change Title: Intel(R) IP Network Server NSC2U, Intel(R) Carrier Grade Server TIGH2U, Intel(R) IP Network Server NSI2U, Intel(R) Carrier Grade Server TIGI2U, PCN 108832-00, Product Material, Change PCI filler panel to Intel standard panel
Date of Publication: September 19, 2008

Key Characteristics of the Change:

Product Material

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	Oct 21, 2008
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Description of Change to the Customer:

Intel changed the PCI slot filler panels (both the full height and low profile) to a more readily available Intel standardized version to improve the component supply line.



Old PCI Filler Panels

New PCI Filler Panels

Removal of the old filler panel is accomplished via a snap-out process using a finger or screwdriver. Removal of the new filler panel requires use of a #2 Philips screwdriver (same tool required to install a PCI card) to loosen the PCI retention screw.

The TA# (Top Assembly #) will not be rolled to solve current material shortages and to minimize disruption of finished goods delivery into the customer supply line.

Customer Impact of Change and Recommended Action:

Impact to the customer is during the PCI card integration process. Removal of the PCI filler panel requires the use of a screw driver to loosen the retention screw (the old version filler panel was a snap-out removal). Otherwise PCI card installation and system service remains the same.

The new filler panel design has passed system level testing for EMI, and shock and vibration.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Post Change TA
TLID2201	883815	D58990-015	D58990-015
TLIA2201	883851	D58988-015	D58988-015
NSIA2100	883852	D58983-009	D58983-009
TLHA0201W	890868	E17592-018	E17592-018
TLHD0201W	890910	E17593-018	E17593-018
NSCD0202W	900074	E49436-004	E49436-004
NSCA0202W	900075	E49435-004	E49435-004

PCN Revision History:

Date of Revision:

September 19, 2008

Revision Number:

00

Reason:

Originally Published PCN